

# Dual N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
20	0.310at V <sub>GS</sub> = 4.5 V	1.2 <sup>a</sup>	1.5 nC			
	0.405at V <sub>GS</sub> = 2.5 V	0.5 <sup>a</sup>	1.5110			

# S<sub>1</sub> 1 6 D<sub>1</sub> G<sub>1</sub> 2 5 G<sub>2</sub> D<sub>2</sub> 3 4 S<sub>2</sub> Top View

SOT-563

#### FEATURES

D.

- DT-Trench Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

G<sub>2</sub> **O**-



Top View		o s1	$\mathbf{b}$ $\mathbf{s}_2$		
ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>A</sub> = 25 °C, unle	ss otherwise not	ed)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 12	v	
	T <sub>C</sub> = 25 °C		1.2 <sup>a</sup>	1	
	T <sub>C</sub> = 70 °C		0.9 <sup>a</sup>		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	0.7 <sup>a, b, c</sup>	A	
	T <sub>A</sub> = 70 °C		0.6 <sup>b, c</sup>		
Pulsed Drain Current	I <sub>DM</sub>	3.5			
	T <sub>C</sub> = 25 °C		1.0		
Martine David Directory	T <sub>C</sub> = 70 °C		0.8		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	0.74 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C		0.47 <sup>b, c</sup>	-	

G<sub>1</sub> **O** 

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	125	160	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	70	95	0/10		

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 220  $^{\circ}\text{C/W}.$

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 vA		30		- mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μΑ		- 2.9			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	0.4		1.2	V	
Cata Cauraa Laakaaa	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 12 V			± 100	μA	
Cate-Source Leakage		V <sub>DS</sub> = 16 V, V <sub>GS</sub> = 0 V		1			
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 16 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	1		10	-μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	3.5			А	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.8 A		0.230	0.258	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 0.4A		0.310	0.350		
	20(01)	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 0.3A		0.405	0.480		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 4 V, I <sub>D</sub> = 0.5 A		3.0		S	
Dynamic <sup>b</sup>				•	•		
Input Capacitance	C <sub>iss</sub>			40		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = - 10 V, $V_{GS}$ = 0 V, f = 1 MHz		35			
Reverse Transfer Capacitance	C <sub>rss</sub>			28			
Total Gate Charge	Qg	$V_{DS}$ = 10 V, $V_{GS}$ = 10 V, $I_{D}$ = 0.5 A		1.5	2.0	- nC	
				0.9	1.8		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_D$ = 0.5 A		0.1			
Gate-Drain Charge	Q <sub>gd</sub>			0.2			
Gate Resistance	Rg	f = 1 MHz		2.6	3.8	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			10			
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, R <sub>L</sub> = 15 $\Omega$		19		- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 0.5 \text{ A}, \text{ V}_{\text{GEN}}$ = 10 V, $R_g$ = 6 $\Omega$		22			
Fall Time	t <sub>f</sub>			8			
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C			0.6	٨	
Pulse Diode Forward Current	I <sub>SM</sub>				1.8	- A	
Body Diode Voltage	V <sub>SD</sub>	$I_{\rm S}$ = 0.8 A, $V_{\rm GS}$ = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$L = 0.6 \text{ A dildt} = 100 \text{ A/us} \text{ T} = 25 ^{\circ} \text{ C}$		6.1		ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 0.6 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		1.5		nC	

Notes:

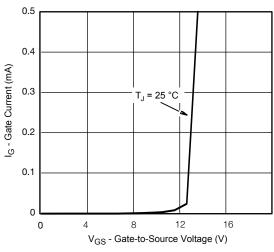
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

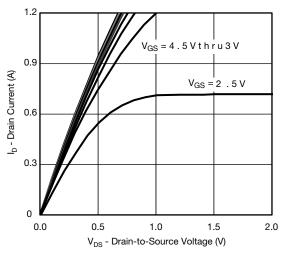
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



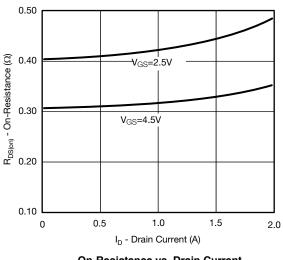
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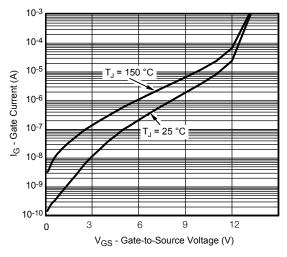
Gate Current vs. Gate-to-Source Voltage



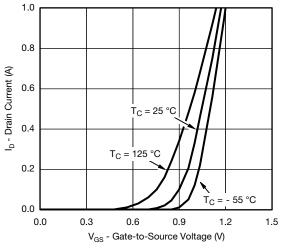
**Output Characteristics** 



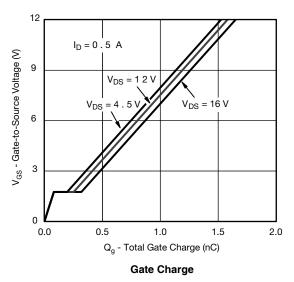
On-Resistance vs. Drain Current



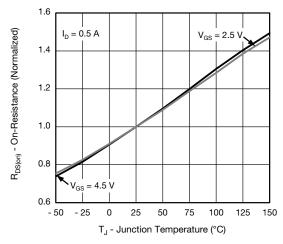
Gate Current vs. Gate-to-Source Voltage



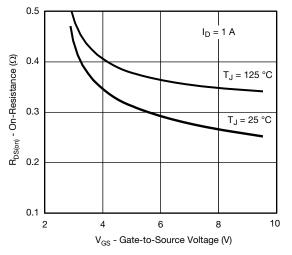




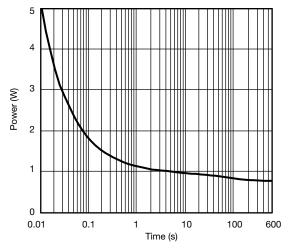
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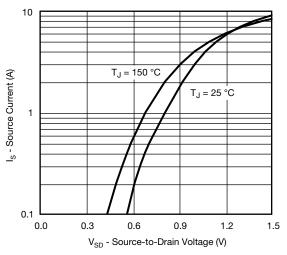
**On-Resistance vs. Junction Temperature** 



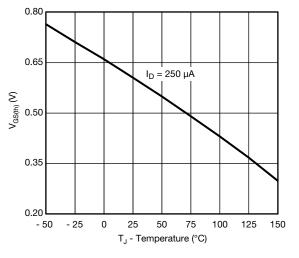
On-Resistance vs. Gate-to-Source Voltage



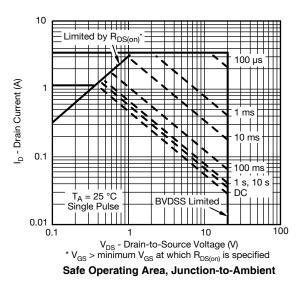
Single Pulse Power, Junction-to-Ambient

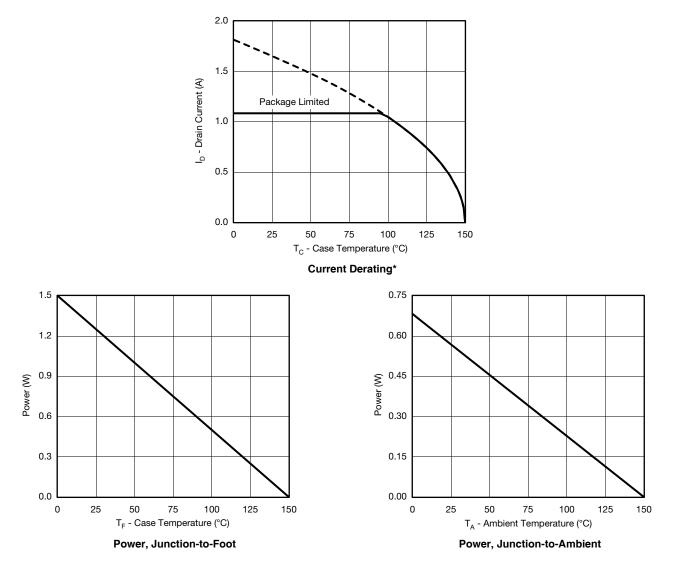


Source-Drain Diode Forward Voltage



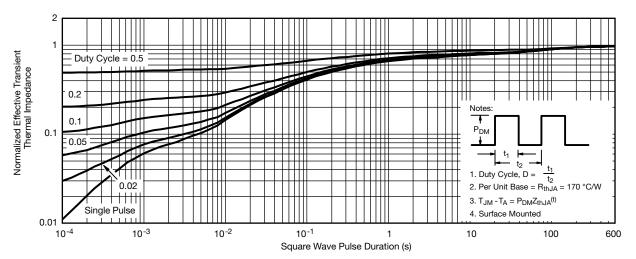
**Threshold Voltage** 



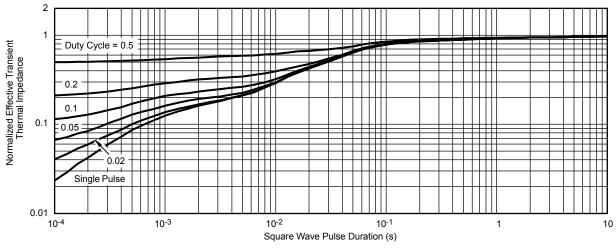


\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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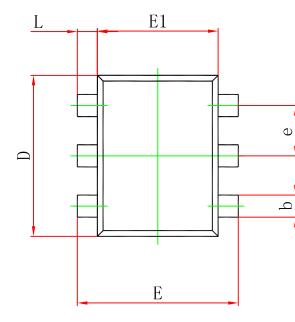
Normalized Thermal Transient Impedance, Junction-to-Ambient

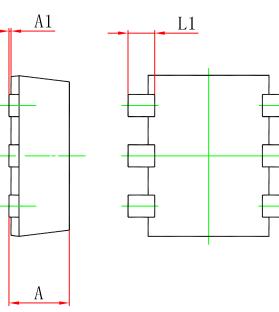


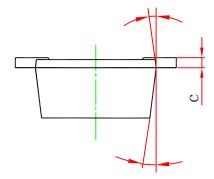
Normalized Thermal Transient Impedance, Junction-to-Foot



### SOT-563 PACKAGE OUTLINE DIMENSIONS



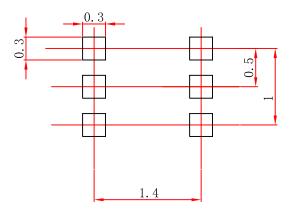




Symbol	Dimensions	In Millimeters	Dimensions in inches		
	Min.	Max.	Min.	Max.	
А	0. 525	0.600	0.021	0.024	
A1	0.000	0.050	0.000	0.002	
е	0. 450	0.550	0.018	0.022	
С	0.090	0.160	0.004	0.006	
D	1.500	1.700	0.059	0.067	
b	0.170	0.270	0.007	0.011	
E1	1.100	1.300	0.043	0.051	
Е	1.500	1.700	0.059	0.067	
L	0.100	0.300	0.004	0.012	
L1	0.200	0. 400	0.008	0.016	
θ	7 0	REF.	7 0	REF.	



#### **RECOMMENDED MINIMUM PADS FOR SOT-563**



1.Unit: mm

2.Package size: 1.6\*1.2

3.Tolerance:  $\pm 0.05$ 



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